HP LTO Ultrium 6 Tape Drives Technical Reference Manual Volume 4: Specifications

Abstract

This is one of five volumes that document HP LTO Ultrium 6 tape drives (Fibre Channel and SAS). This volume details specifications. See "Support and other resources" (page 29) for details of the other guides.



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Warranty

WARRANTY STATEMENT: To obtain a copy of the warranty for this product, see the warranty information website:

http://www.hp.com/go/storagewarranty

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1 Features

Feature		Specification			
Recording format		Linear Serpentine Ultrium-6 and Ultrium-5. LTO Ultrium-4 tapes can be read but not written.			
Data compression		ALDC			
Data encoding method		16-channel 32/33 RLL NPML			
Variable speed recordi	ng	54–160 MB/s Ultrium-6 ¹			
Read-While-Write		Standard—data is verified immediately after it is written			
Auxiliary memory in co	artridge (CM)	Standard 16K LTO-CM as part of Ultrium format			
Data interfaces	FC:	8 Gb/s dual port Fibre Channel			
	SAS:	6 Gb/s dual port SAS			
Library interface (ACI/	ADI)	Bi-directional RS422 (serial protocol RS422 9600 to 153600 baud)			
Management Interface	(iADT)	Ethernet (10Base-T and 100 Base-TX)			
Main data buffer size		512 MB			
Burst buffer size		2 MB (FC and SAS—embedded DRAM)			

Decimal MB/s including wrap turn-around and up to 1% dataset re-writes.

Data security features

Description	Specification		
Data encryption	AES-GCM 256		
Certification level	FIPS 140–2 certification level 1 and level 2		

Tape partitioning features

Description	Specification		
Number of partitions	4 (LTO-6 tape), 2 (LTO-5 tape)		
Data encryption	Supported as per U-516 and U-616 LTO-6 format specification		
WORM cartridge	Partitioning a WORM cartridge is not supported as per U-616 Annex L		

2 Physical specification

Dimensions

		Full-height	Half-height
Internal width		146.07 ± 0.25 mm (5.75")	146.05 ± 0.25 mm (5.75")
	height:		41.65 ± 0.25 mm (1.64")
	depth:	203.0 ± 0.8 mm (7.99")	206.00 ± 0.25 mm (8.11")*
External (SAS only)	width:	218 mm (8.58")	224 mm (8.82")
height:		120 mm (4.72")	79 mm (3.11")
	depth:	297 mm (11.69")	301 mm (11.85")

Full-height drives

Figure 1 Full-height drives—plan

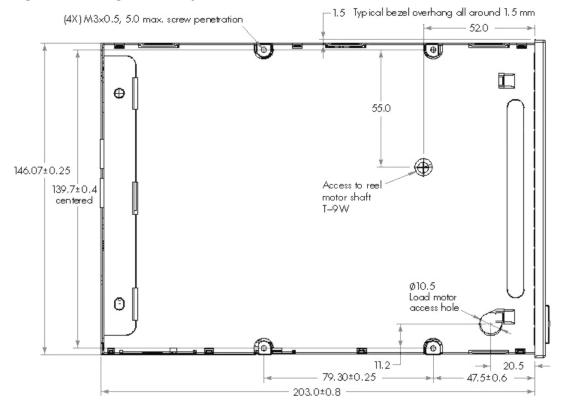


Figure 2

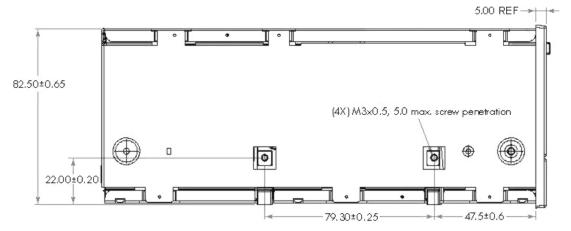
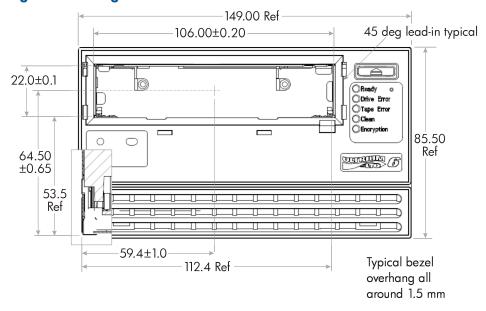


Figure 3 Full-height drives—front



NOTE: The diagram shows the Automation bezel.

Figure 4 Full-height drives—rear view (Fibre Channel)

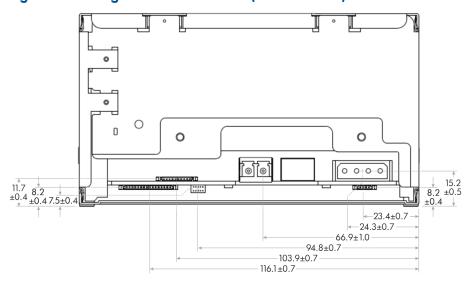
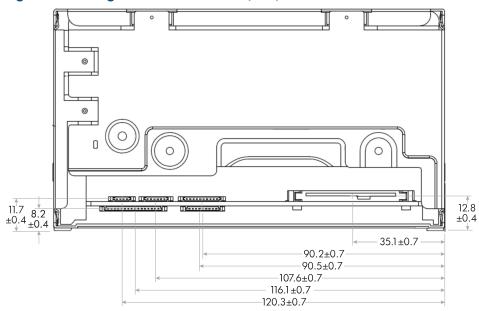


Figure 5 Full-height drives—rear view (SAS)



Half-height drives

Figure 6 Half-height drives—plan

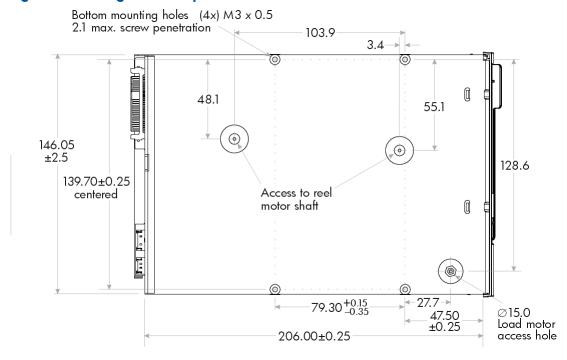
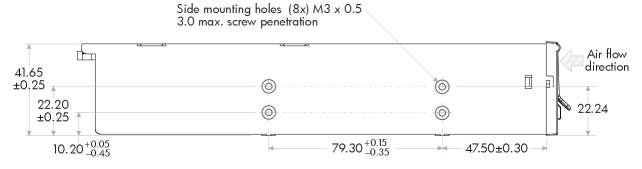


Figure 7 Half-height drives—side (general dimensions)



NOTE: The diagram shows the System bezel.

Figure 8 Half-height drives—side (Fibre Channel)

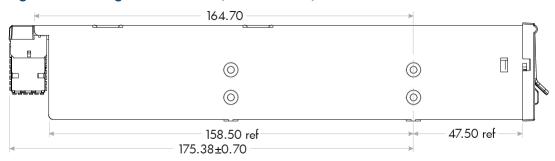


Figure 9 Half-height drives—side (SAS)

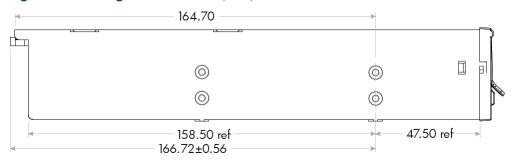
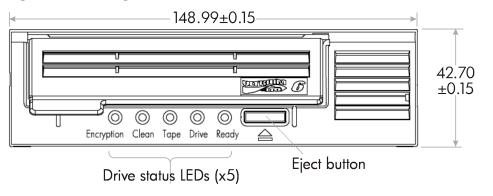


Figure 10 Half-height drives—front



NOTE: Figure 10 shows the system bezel.

Figure 11 Half-height drives—rear view (Fibre Channel)

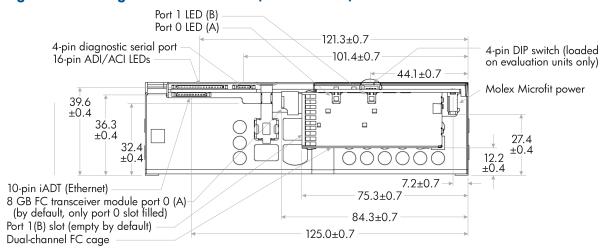
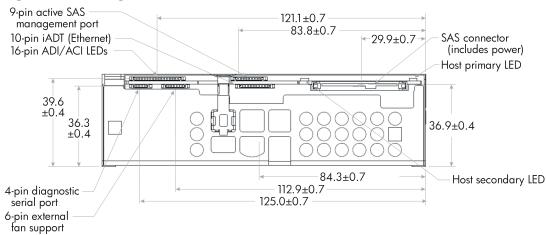


Figure 12 Half-height drives—rear view (SAS)



Product weight

	Full-height	Half-height
Internal*	2.31 kg (typical)	1.45 kg (typical)
External	TBD	TBD

^{*}including front panel and ESD bag but excluding rails

Drive orientation

HP LTO Ultrium drives will operate in 0° , -90° and $+90^{\circ}$ orientations when viewed from the front panel. In addition, in the 0° axis, the drive will operate with $+20^{\circ}$ nose-up tilt.

3 Electrical requirements

DC voltage specifications

	5	iV .	12V		
Maximum voltage	5.2	25V	13.2V		
Minimum voltage	4.7	75V	10.8V		
Typical current	3.50A (FH)	3.51A (HH)	0.60A (FH)	0.60A (HH)	
Maximum current	<4.00A (FH)	<4.10A (HH)	<2.60A (FH)	<2.30A (HH)	

Maximum currents drawn from the power supplies

Full-height Fibre Channel drives

The following are the maximum currents drawn from the power supplies for the HP LTO Ultrium 6 full-height tape drive fitted with a single SFP transceiver from a sample of CR2 drives.

Mode	5V (avg)	5V (max) 1 ms RMS	5V (max) 20 ms RMS	12V (avg)	12V (max) 1 ms RMS	12V (max) 20 ms RMS
Power on	1.01 A	1.60A	1.51 A	0.06A	1.17A	0.73A
Idle	1.27A	n/a	n/a	0.15A	n/a	n/a
Unload	1.35A	1.44A	1.43A	0.38A	1.50A	1.31 A
Load ¹	1.19A	1.38A	1.37A	0.37A	1.39A	1.35A
Write ¹	3.44A	3.91A	3.75A	0.54A	2.52A	1.94A
Read	2.51 A	2.57A	2.55A	0.54A	1.58A	1.20A
Space to EOD	1.75A	1.80A	1.73A	0.60A	2.60A	2.02A

¹ Write and Read average values are taken over two full wraps Write and Read RMS values include the peaks from the motor start-up ramps.

Full-height SAS drives

The following are the maximum currents drawn from the power supplies for the HP LTO Ultrium 6 full-height SAS drive from a sample of CR2 drives.

Mode	5V (avg)	5V (max) 1 ms RMS	5V (max) 20 ms RMS	12V (avg)	12V (max) 1 ms RMS	12V (max) 20 ms RMS
Power on	TBD	TBD	TBD	TBD	TBD	TBD
Idle	TBD	n/a	n/a	TBD	n/a	n/a
Unload	TBD	TBD	TBD	TBD	TBD	TBD
Load	TBD	TBD	TBD	TBD	TBD	TBD
Write ²	TBD	TBD	TBD	TBD	TBD	TBD
Read ²	TBD	TBD	TBD	TBD	TBD	TBD
Space to EOD	TBD	TBD	TBD	TBD	TBD	TBD

Write and Read average values are taken over two full wraps.
Write and Read RMS values include the peaks from the motor start-up ramps.

NOTE: HP Ultrium LTO-6 SAS tape drives are powered via the SAS connector and do not have a regular 4-pin power connector.

Half-height Fibre Channel drives

The following are the maximum current drawn from the power supplies for the HP LTO Ultrium 6 half-height FC tape drive from a sample of CR2 drives.

Mode	5V (avg)	5V (max) 1 ms RMS	5V (max) 20 ms RMS	12V (avg)	12V (max) 1 ms RMS	12V (max) 20 ms RMS
Power on	1.23A	1.55A	1.54A	0.17A	1.47A	0.95A
Idle	1.33A	n/a	n/a	0.18A	n/a	n/a
Unload	1.44A	1.51 A	1.49A	0.50A	2.21A	1.90A
Load	1.29A	1.50A	1.41A	0.42A	2.08A	1.67A
Write ⁴	3.51A	4.06A	3.85A	0.58A	1.14A	1.10A
Read ⁴	2.56A	2.61 A	2.61A	0.59A	1.23A	1.09A
Space to EOD	1.798A	1.93A	1.81A	0.66A	1.70A	1.63A

 $^{^4}$ Write, Read and Erase average values are taken over two full wraps. Write and Read RMS values include the peaks from the motor start-up ramps.

Half-height SAS drives

The following are the maximum current drawn from the power supplies for the HP LTO Ultrium 6 half-height SAS tape drive from a sample of CR2 drives.

Mode	5V (avg)	5V (max) 1 ms RMS	5V (max) 20 ms RMS	12V (avg)	12V (max) 1 ms RMS	12V (max) 20 ms RMS
Power on	TBD	TBD	TBD	TBD	TBD	TBD
Idle	TBD	n/a	n/a	TBD	n/a	n/a
Unload	TBD	TBD	TBD	TBD	TBD	TBD
Load	TBD	TBD	TBD	TBD	TBD	TBD
Write ²	TBD	TBD	TBD	TBD	TBD	TBD
Read ²	TBD	TBD	TBD	TBD	TBD	TBD
Space to EOD	TBD	TBD	TBD	TBD	TBD	TBD

³ Write, Read and Erase average values are taken over two full wraps. Write and Read RMS values include the peaks from the motor start-up ramps.

NOTE: HP Ultrium LTO-6 SAS tape drives are powered via the SAS connector and do not have a regular 4-pin power connector.

Power consumption specifications

Full-height drives

The following are the maximum power consumptions drawn from the power supplies for the HP LTO Ultrium 6 full-height tape drive from a sample of CR2 drives.

Description	scription FC internal			SAS internal		
	Average	Peak 1 ms RMS	Peak 20 ms RMS	Average	Peak 1 ms RMS	Peak 20 ms RMS
Total power	<24W	<50W	<42W	TBD	TBD	TBD
5V power	<18W	<20W	<19W	TBD	TBD	TBD
12V power	<8W	<32W	<25W	TBD	TBD	TBD
	Power consumption					
Power-up	5.77W	21.44W	16.26W	TBD	TBD	TBD
Idle	8.05W	n/a	n/a	TBD	n/a	n/a
Unload	11.21W	24.85W	22.52W	TBD	TBD	TBD
Load	10.34W	23.43W	23.05W	TBD	TBD	TBD
Write	23.68W	49.79W	41.23W	TBD	TBD	TBD
Read	19.03W	31.81W	27.14W	TBD	TBD	TBD
Space to EOD	15.71W	40.10W	32.74W	TBD	TBD	TBD

Half-height drives

The following are the maximum power consumptions drawn from the power supplies for the HP LTO Ultrium 6 half-height tape drive from a sample of CR2 drives.

Description	ription FC internal		SAS internal			
	Average	Peak 1 ms RMS	Peak 20 ms RMS	Average	Peak 1 ms RMS	Peak 20 ms RMS
Total power	<24W	<50W	<42W	TBD	TBD	TBD
5V DC power	<18W	<20W	<19W	TBD	TBD	TBD
12V DC power	<8W	<32W	<25W	TBD	TBD	TBD
	Power consumption					
Power-up	8.18W	25.34W	19.00W	TBD	TBD	TBD
Idle	8.81W	n/a	n/a	TBD	n/a	n/a
Unload	13.20W	34.07W	30.10W	TBD	TBD	TBD
Load	11.49W	32.46W	27.09W	TBD	TBD	TBD
Write	24.41W	33.67W	32.45W	TBD	TBD	TBD
Read	19.76W	27.81W	26.13W	TBD	TBD	TBD
Space to EOD	16.87W	29.25W	28.61W	TBD	TBD	TBD

Power-saving (hibernate) mode

Full-height drives

The following are the maximum power consumptions during power-saving (hibernate) mode, drawn from the power supplies for the HP LTO Ultrium 6 full-height tape drive from a sample of CR2 drives.

Description	FC internal	SAS internal
	Average	Average
Total power	4.15W	TBD
5V power	4.15W	TBD
12V power	0.00₩	TBD

Half-height drives

The following are the maximum power consumptions during power-saving (hibernate) mode, drawn from the power supplies for the HP LTO Ultrium 6 half-height tape drive from a sample of CR2 drives.

Description	FC internal	SAS internal	
	Average	Average	
Total power	4.45W	TBD	
5V power	4.45W	TBD	
12V power	0.00W	TBD	

4 Electromagnetic compatibility

NOTE: The EMC performance of internal storage products depends on the characteristics of the system in which the product is installed. HP has tested products installed in server enclosures and in external desktop enclosures to verify EMC performance against the regulatory standards in force at the time of introduction.

Products will comply with new regulatory standards by or before the date of withdrawal of the superseded standards, during their prodution life.

EMC test specification

The following are the specifications for an internal drive configuration.

General standard	Reference standards	Test description	Test level/class
CISPR 22:1997	CISPER 16-1:1993	Radiated Emissions	Class B
EN 55022:1998	CISPR 16-1:1993	Radiated Emissions	Class B
VCCI	CISPR 22:1997	Radiated Emissions	Class B
FCC CFR 47 Part 15	ANSI C63.4:2003	Radiated Emissions	Class B 30 Mhz – 2.0 GHz
EN 55024:1998+A1+A2 CISPR 24:1997+A1 +A2	EN/IEX 61000-4-2:1995	Electrostatic Discharge	10.5 kV Air and 6.3 kV Contact
EN 300 386:2001 + Extended Additional Requirements	EN/IEC 61000-4-3:1995	Radiated RF Interference	12 V/m 80% AM, 80-2000 MHz
·	EN/IEC 61000-4-3:1995	Radiated RF Interference	3 V/m, 1 KHz PM, 1–4 GHz

The following are the specifications for an external drive configuration.

General standard	Reference standards	Test description	Test level/class
FCC CFR 47 Part 15	ANSI C63.4:2003	Radiated Emissions	Class B 30 MHz—2 GHz
VCCI	CISPR 22:1997	Emissions	Class B
CISPR 22:1997	CISPR 16-1:1993	Emissions	Class B
EN 55022:1998	CISPR 16-1:1993	Emissions	Class B
EN/IEC 61000-3-3	IEC 61000-3-3:1994 and A 1 : 2001	Flicker	Pst = Plt = 0.65
EN/IEC 61000-3-2	IEC 61000-3-2:2000	Harmonics	Class A
	EN/IEC 61000-4-2:1995	Electrostatic discharge	10.5 kV Air and 6.3 kV Contact
	EN/IEC 61000-4-3:1995	Radiated RF interference	80-2000 MHz, 12 V/m AM
	EN/IEC 61000-4-3:1995	Radiated RF interference	1-4 GHz, 3 V/m PM
EN 55024:1998+A1	EN/IEC 61000-4-4:1995	Fast transients bursts	2.2 kV AC Power Port
CISPR 24:1997+A1 EN 300 386:2001 +	EN/IEC 61000-4-4:1995	Fast transients bursts	1.1 kV Signal Port
Extended Additional Requirements	EN/IEC 61000-4-5:1995	Lightning surge	1.65 kV L-L
	EN/IEC 61000-4-5:1995	Lightning surge	3.3 kV L-E
	EN/IEC 61000-4-5:1995	Lightning surge	2.2 kV L-E and 1.1 kV L-L

General standard	Reference standards	Test description	Test level/class
	EN/IEC 61000-4-6:1996	Conducted RF field	5V (all ports)
	EN/IEC 61000-4-11:1994	Voltage dip	30% 0.5s and 1s
	EN/IEC 61000-4-11:1994	Voltage dip	100% 10 ms and 20m
	EN/IEC 61000-4-11:1994	Voltage dip	100% 5s

ITE emissions

	Standards	
Parameter	International	European Economic Area
Radiated and conducted*	CISPR 22:2005 FCC CFR 47 Part 15, referencing ANSI C63.4-2003 (U.S.A. only)	EN 55022:2006
Harmonic current*	IEC 61000-3-2:2000 + Amendment 1:2001 + Amendment 2:2004	EN 61000-3-2:2000 + /A2:2005
Voltage fluctuations and flicker*	IEC 61000-3-3:1994 + Amendment 1:2001	EN 61000-3-3:1995 + /A1:2001

^{*}The marked standard applies to external (desktop) products only

ITE immunities

	Stan	dards
Parameter	International	European Economic Area
Generally	CISPR 24:1997 + Amendment 1:2001 + Amendment 2:2002 referencing the following:	EN 55024:1998 + /A1:2001 + /A2:2003 referencing the following:
Electrostatic discharge	IEC 61000-4-2:1995	EN 61000-4-2:1995
Radiated RF electromagnetic field	IEC 61000-4-3:1995	EN 61000-4-3:1996
Electrical fast transient/Burst*	IEC 61000-4-4:1995	EN 61000-4-4:1995
Surge*	IEC 61000-4-5:1995	EN 61000-4-5:1995
Conducted disturbances by RF fields*	IEC 61000-4-6:1996	EN 61000-4-6:1996
Power frequency magnetic field	IEC 61000-4-8:1993	EN 61000-4-8:1993
Voltage dips, interruptions & variations*	IEC 61000-4-11:1994	EN 61000-4-11:1994

^{*}The marked standard applies to external (desktop) products only

DC magnetic field inteference

IATA Dangerous Goods Regulations, 2007, 48th edition

5 Environmental

Climatics

These apply to the mechanism unless otherwise noted. For the environmental specification of media, see "Media" (page 21).

Operating

Parameter	Specification		
Operating temperature with media		Full-height	Half-height
	10°C to 35°C (50°F to 95°F)	6 cfm	4 cfm
	10°C to 40°C (50°F to 104°F)	8 cfm	6 cfm
Maximum operating temperature rise	10°C/hr (50°F/hr)		
Operating non-condensing humidity	20% to 80% RH		
Maximum operating humidity rise	<30%/hr		
Maximum wet bulb temperature 26°C (79°F)			
Operating altitude	0 to 4 km (0 to 13,000 ft)		

Non-operating

Parameter	Specification
Non-operating temperature	-40°C to 66°C (-40°F to 151°F)
Maximum non-operating temperature rise	20°C/hr (68°F/hr)
Non-operating humidity	10% to 95% RH
Non-operating humidity rise	30%/hr
Non-operating altitude	0 to 15.25 km (0 to 50,000 ft)

General

Parameter	Specification
Suspended particle density	<200 μg/m ³

Dynamics

Description	Mode	Specification
Vibration (Brick)	Operating (3 axes)	Random: 0.31G rms 5 to 500 Hz 0.000194 g ² /Hz
		Swept Sine: 0.31G peak 5 to 500 Hz @ 1 octave/min 15 minute dwell at peak resonance
Operating Margin	Operating Margin Characterized*	Random: 1.0 G rms 5 to 500 Hz 0.00202 g ² /Hz
	(3 axes)	Swept Sine: Full Height: 0.75G peak 5 to 500 Hz @ 1 octave/min Half Height: 0.5G peak 5 to 500 Hz @ 1 octave/min

Description	Mode	Specification	
		15 min dwell at major resonance	
	Non-Operating (3 axes)	Random: (approx. 2.41G rms 5 to 500 Hz) 5-100 Hz 0.001961 g ² /Hz 100-137 Hz @ -6 dB/octave 137-350 Hz 0.01079 g ² /Hz 350-500 Hz @ -6 dB/octave 500Hz 0.0052 g ² /Hz	
		Swept sine: Full Height: 1.0G peak, 5 to 500Hz @ 1 octave/min Half Height: 0.75G peak, 5 to 500 Hz @ 1 octave/min 5 minute dwell at major resonance	
	Non-Operating Margin Characterized* (3 axes)	Swept sine: Full Height: 1.5G peak, 5 to 500 Hz @ 0.5 octave/min Half Height: 1.0G peak, 5 to 500 Hz @ 0.5 octave/min 15 minute dwell at major resonance	
Shock (Brick–all six faces)	Operating	5G peak 3 ms (half sine)—no performance change 2G peak 11 ms (half sine)—no performance change 8G peak 11 ms (half sine)—no data loss Pulse Rate 1 pulse every 10 sec, +ve and -ve direction 1800 shock pulses per test	
	Operating Margin Characterized*	62G peak 2 ms (half sine)—no data loss Pulse rate 1 pulse every 10 sec, +ve and -ve direction 600 shock pulses per test	
	Non-Operating	90G peak 3 ms (half sine)—no damage 33G peak 11 ms (half sine)—no damage (FH only) 30G peak 26 ms (trapezoidal)—no damage	
	Non-Operating Margin Characterized *	200G peak 2.6 ms (half sine)—no damage with cartridge loaded and threaded	
Handling Drop	Non-Operating	Unpackaged Shock: One drop per bottom corner free fall from 100 mm, while rotating about the edge on the other two corners, each corner stands on a 10 mm and 20 mm spacer respectively. Drop a total of four bottom corners	
Transportation (Vibration—single pack)	Vibration (3 axes)	Swept sine: 0.5G peak 5–200–5 Hz @ 1 octave/min 5 min dwell at peak resonance Random: approx. 1.47G rms (30 min/axis) 5–100 Hz 0.015 g ² /Hz 100–200 Hz @ –6dB/octave 200 Hz 0.0038 g ² /H	
		Drop height = 0.91m (36 in) 10 vertical impacts (6 faces and 4 bottom corners)	
Transportation (Palletized—normal	Vibration	Swept sine: 0.5 G peak 5–200–5 Hz @ 1 octave/min 5 min dwell at peak resonance	
shipping axes only)		Random: approx. 1.47G rms (30 min/axis) 5–100 Hz 0.015 g ² /Hz 100–200 Hz @ -6dB/octave 200Hz 0.0038 g ² /H	
	Shock	Drop height = 0.30m (12 in) 5 impacts (1 vertical flat base, 4 rotational edges)	

*HP test philosophy is to test the product to failure so that the product margin can be characterized against the normal operating and non-operating specifications.

Noise

Parameter	Specification
Operating acoustic noise	<5.0 bel sound power

Airflow

 $\ensuremath{\mathsf{HP}}$ LTO Ultrium drives require forced airflow from front to back.

	Full-height drives	Half-height drives
Airflow (up to 35°C ambient)	0.17 m ³ /min (6 cu ft/min)	0.11 m ³ /min (4 cu ft/min)
Pressure drop required (up to 35°C ambient)	0.015 inches H ₂ O	0.042 inches H ₂ O
Airflow (up to 40°C ambient)	0.23 m ³ /min 8 cu ft/min)	0.17 m ³ /min (6 cu ft/min)
Pressure drop required (up to 40°C ambient)	0.026 inches H ₂ O	0.085 inches H ₂ O

6 Safety

Safety and EMC agency requirements

Country	Agency	Scope	Config	FC	SAS	Notes
USA	UL	Safety	Internal	Y	Υ	
			External	N/A	Υ	
	FCC	EMC	_	Y	Υ	Refer to DoC
Canada	CSA	Safety	_	Y	Υ	Refer to UL
	ICES	EMC	_	Y	Υ	Refer to DoC
Mexico	NOM	Safety	External	N/A	Υ	
Europe	CE	Safety-EMC	Internal	Y	Υ	DoC
			External	N/A	Υ	DoC
Germany	TUV	Safety	Internal	N/A	Υ	Refer to UL
			External	N/A	Υ	Refer to UL
Russia	GOSH	Safety-EMC	External	N/A	Υ	
South Africa	SABS	Safety-EMC	External	N/A	Υ	
Taiwan	BSMI	Safety-EMC	Internal	N/A	Υ	
			External	N/A	Υ	
Korea	RRL	EMC	Internal	N/A	Υ	
			External	N/A	Υ	
Australia	C-Tick	Safety-EMC	Internal	N/A	Υ	
New Zealand			External	N/A	Υ	
Japan	VCCI	EMC	External	N/A	Υ	

Transceivers

The Fibre Optic transceivers used in FC products are Class 1 Laser components and comply with US FDA regulations.

These components are certified to meet the Class 1 eye safety requirements of EN (IEC) 60825 and the electrical safety requirements of EN (IEC) 60950.

7 Media

Specification

HP Product Number	Format	Capacity*	Notes
C7976A	Ultrium-6	6250 GB	Read and write
C7976W	Ultrium-6 WORM	6250 GB	Write once, read many times
C7975A	Ultrium-5	3000 GB	Read and write
C7975W	Ultrium-5 WORM	3000 GB	Write once, read many times
C7974A	Ultrium-4	1600 GB	Read
C7974W	Ultrium-4 WORM	1600 GB	Read

^{*}Capacities at 2:1 data compression for LTO4 and LTO5 and at 2.5:1 data compression for LTO6. The actual capacity depends on the compression ratio of the data.

NOTE: The HP Ultrium LTO-6 tape drives does not support Ultrium-3 R/W, Ultrium-2 R/W and Ultrium-1 R/W cartridges (10, 30, 50 and 100 GB cartridges). HP recommends the use of the "set capacity" SCSI command to logically shorten standard cartridges for test purposes.

		Ultrium-6	Ultrium-5	Ultrium-4
Media	Media capacities (native) ¹	2.5 TB	1.5 TB	0.8 TB
	Media type (base film):	Metal Particle or Barium Ferrite (Poly-Ethylene-Napthalate) or equivalent	Metal Particle PEN (Poly-Ethylene-Napthalate) or equivalent	Metal Particle PEN (Poly-Ethylene-Naphthalate)
	Total tape length (±1.0 m):	846m	846m	820m
	Tape length used for data:	808m	808m	783m
	Tape width:	12.65 mm	12.65 mm	12.65 mm
	Tape thickness:	6.4 -0.2/+0.3 µm (MP) 6.4 -0.2/+0.3 µm or 6.1 -0.2/+0.3 µm (BaFe)	6.4 -0.2/+0.3 μm	6.6 -0.2/+0.3 μm
	Tape dimensional stability:	Total < 750 ppm Env. < 500 ppm Tension < 200 ppm Ageing < 150 ppm	Total < 875 ppm Env. < 550 ppm Tension < 300 ppm Ageing < 200 ppm	900 ppm
	Rewind speed:		9.00 m/s	
Cartridge	Weight:		0.220 kg	
	Width:		105.4±0.30 mm	
	Height:		21.5±0.25 mm	
	Depth:		102.0±0.30 mm	
	Cartridge memory capacity	16384 bytes	8192 bytes	8192 bytes
Recording layout	Track pitch:	4.75 μm	8.10 µm	11.48 µm
	Track density (TPI):	5330	3136	2212

	Ultrium-6	Ultrium-5	Ultrium-4
Data tracks:	2176	1280	896
Number of wraps:	136	80	56
Number of data bands:	4	4	4
RLL recording bit density ² :	15.143 Kb/mm (384.6 Kb/in)	15.143 Kb/mm (384.6 Kb/in)	13.52 Kb/mm (343.4 Kb/in)

¹ Decimal MB

Environmental specifications (media)

Operating

Parameter	Specification
Ambient Temperature	10°C to 45°C (50°F to 113°F)
Relative Humidity (non-condensing)	10%* to 80%
Maximum Wet Bulb Temperature	26°C (78.8°F)

^{*} The media is specified to operate down to 10% RH as a margin beyond the minimum specified for the operating drive (20%).

Storage (day-to-day)

Parameter	Specification
Ambient Temperature	16°C to 35°C (60°F to 95°F)
Relative Humidity (non-condensing)	20% to 80%
Maximum Wet Bulb Temperature	26°C (78.8°F)
Media archive life	30 years

Storage (transportation)

Parameter	Specification
Ambient Temperature	-23°C to 49°C (-9.4°F to 102°F)
Relative Humidity (non-condensing)	5% to 80%
Maximum Wet Bulb Temperature	26°C (78.8°F)

Storage (archival)

Archival storage is recommended for cartridges that need to be stored more than six months. Cartridges should be stored in plastic containers, preferably on their sides.

Parameter	Specification
Ambient Temperature	5°C to 23°C (41°F to 73°F)
Relative Humidity (non-condensing)	20% to 60%

² RLL recording bit density

Parameter	Specification
Maximum Wet Bulb Temperature	26°C (78.8°F)
Archive Life	30 years

LTO-Cartridge Memory (EEPROM)

LTO Cartridge Memory (LTO-CM) is EEPROM that is embedded in every LTO Ultrium tape cartridge. It is non-volatile and is contactless in that it is read by RF coupling rather than electrical contact.

Interface specification

- Contactless, passive RF interface using a proximity inductive coupling with a range in the order of millimeters.
- Power to the transponder is coupled through the interface.
- The range depends on implementation (maximum 10 to 20 mm). The best error rate performance occurs at short distances.
- The memory can be read from below (by a drive) or the front (in libraries).
- LTO6: 16384 bytes, LTO5 and LTO4: 8192 bytes
- Organized as 511? x 32 byte blocks
- >500K write cycles, 20 year data retention life
- Write/read size is word-wide (2 bytes) or block-wide (32 bytes)

Further information

• For suggestions of how to make use of cartridge memory in libraries, see "LTO Cartridge Memory (LTO-CM)" in Chapter 5, "Supporting LTO Ultrium Features" in the Software Integration Guide, Volume 2 of the HP LTO Ultrium Technical Manual.

8 LTO Ultrium format standard

Compatibility

HP LTO Ultrium 6 drives are specified to interchange data cartridges with other tape drives that comply to the LTO U-316, U-416 and U-516 specification documents:

Capacity	Format	Write	Read
6250 GB (write/read) at 2.5:1 compression	LTO Ultrium-6	Yes	Yes
6250 GB WORM at 2.5:1 compression	LTO Ultrium-6	Yes	Yes
3000 GB (write/read) at 2:1 compression	LTO Ultrium-5	Yes	Yes
3000 GB WORM (write/read) at 2:1 compression	LTO Ultrium-5	Yes	Yes
1600 GB WORM (write/read) at 2:1 compression	LTO Ultrium-4	No	Yes
1600 GB (write/read) (write/read) at 2:1 compression	LTO Ultrium-4	No	Yes
800 GB WORM (write/read) at 2:1 compression	LTO Ultrium-3	No	No
800 GB (write/read) (write/read) at 2:1 compression	LTO Ultrium-3	No	No
400 GB (write/read) (write/read) at 2:1 compression	LTO Ultrium-2	No	No
200 GB (write/read) (write/read) at 2:1 compression	LTO Ultrium-1	No	No
100 GB (write/read) (write/read) at 2:1 compression	LTO Ultrium-1	No	No

This specification only applies when:

- Cartridges carry the LTO Ultrium logo.
- Cartridges are not damaged or faulty.
- Cartridges are read on a drive in good operating condition, and have been written on a logo-certified drive in good condition.
- Environmental conditions (including DC voltage supplies) are within the specified limits.

Future compatibility

In future, HP LTO Ultrium drives will always be capable of reading and writing tapes from the current generation and one generation before, and reading tapes from two generations before. HP LTO Ultrium drives will always maintain write and read compatibility with other manufacturers' LTO Ultrium drives and tapes that meet the LTO Ultrium format specification.

9 Reliability

Description	Specification
MTBF (100% duty cycle)	250,000 hours
Load/unload life (only valid when the drive is operated in a	Full-height: 120,000 cycles
standard office environment)	Half-height: 80,000 cycles
Population MSBF	100,000 cycles
Head life (typical)	60,000 hours
Reposition life	1,000,000 cycles (media limited)
Lifetime of drive (5 years at 100% duty cycle)	43,800 hours
Maximum cartridge uses	20,000 threads
Cartridge Extraction Force	2.25N to 5.8N (0.5 lbf to 1.3 lbf)
Backup failure rate	<0.1%
Restore failure rate	<0.001%
Interchange failure rate	<0.1%
Uncorrectable error rate	1 in 10 ¹⁷ bits
Undetected error rate	1 in 10 ²⁷ bits

10 Performance specification

The drive will match the throughput of any host up to the maximum supported transfer rate using the Data Rate Matching (DRM) functionality. There is no performance penalty for hosts that are slower than the maximum supported transfer rate. This capability is accomplished using buffer management for transfer rates of 0 MB/s up to the minimum tape streaming transfer rate, and the Adaptive Tape Speed (ATS) technology from the minimum to maximum tape streaming transfer rate.

Transfer rates

Maximum sustained transfer rate	Native:	160 MB/s
	Compressed (2.5:1):	400 MB/s
	Any compression:	750 MB/s
Streaming native data rate range		54-160 MB/s (LTO-6)
		47–140 MB/s (LTO-5)
		44–120 MB/s (LTO-4)
Burst transfer rate	FC:	800 MB/s
	SAS:	600 MB/s
Maximum block size	without encryption:	16 MB
with encryption:		8 MB
Compression engine bandwidth		750 MB/s
Encryption engine bandwidth		750 MB/s

The drive will match the throughput of any host up to the maximum supported transfer rate using the Data Rate Matching (DRM) functionality. There is no performance penalty for hosts that are slower than the maximum supported transfer rate. This capability is accomplished using buffer management for transfer rates of 0 MB/s up to the minimum tape streaming transfer rate, and the Adaptive Tape Speed (ATS) technology from the minimum to maximum tape streaming transfer rate.

Data compression

The compression engine uses an enhanced algorithm based on ALDC where data expansion due to redundant data is minimized. This is achieved by having two compression schemes (normal and pass-through) with the ability to switch dynamically between them.

It is possible to force the drive to turn off Data Compression using the Data Compression mode page or the SDCA parameter in the Sequential Access Mode Page.

Speeds

Tape read/write speed	7.12 m/s (LTO-6) 6.04 m/s (LTO-5) 6.20 m/s (LTO-4)
Tape rewind speed	9.00 m/s

Timings

Capacity full backup times

The following table shows approximate backup times for supported tape cartridges:

Cartridge	Time
6250 GB LTO-6	4.34 hours
3000 GB LTO-5	2.96 hours
1600 GB LTO-4	1.94 hours

Load/unload times

	LTO6 FH	LTO6 HH
Typical load time to BOT, ready to write from start of load		
Standard LTO6 RW cartridge	22s	24s
LTO6 WORM cartridge (initalized) ¹	25s	26s
Typical unload time, excluding rewind		
Standard LTO6 RW cartridge	19s	19s
LTO6 WORM cartridge (initalized)	22s	23s
Automation eject (after the tape is unthreaded)	<1s	<1s

¹ Unitialized WORM cartridges take longer to load.

Access times (time to data)

		Time
Average access time from BOT to MOT	6250 GB LTO-6:	50s
	3000 GB LTO-5:	TBD
	1600 GB LTO-4:	TBD
Maximum access time from BOT to EOT	6250 GB LTO-6:	99s
	3000 GB LTO-5:	TBD
	1600 GB LTO-4:	TBD

Other times

Parameter	Time
Mean reposition time	2.50s
Turn-around time at end of wrap	1.5s max.
Time to rewind EOT-BOT	Ultrium-6: 98s Ultrium-5: TBD Ultrium-4: TBD
Time to rewind MOT-BOT	Ultrium-6: 51s Ultrium-5: TBD

Parameter	Time
	Ultrium-4: TBD
Cleaning time with a cleaning cartridge	58–152s

11 Support and other resources

Related documents

The following documents provide additional information:

Documents specific to HP LTO Ultrium drives

- Hardware Integration Guide, volume 1 of the HP LTO Ultrium Technical Reference Manual
- Software Integration Guide, volume 2 of the HP LTO Ultrium Technical Reference Manual
- Host Interface Guide, volume 3 of the HP LTO Ultrium Technical Reference Manual
- UNIX, Linux and OpenVMS Configuration Guide, volume 5 of the HP LTO Ultrium Technical Reference Manual

Please contact your HP supplier for copies.

- The features and benefits of HP LTO Ultrium drives are discussed in the HP LTO Ultrium Technology White Paper.
- For a general background to LTO technology and licensing, go to http://www.lto-technology.com.

Documentation map

The following will help you locate information in the Technical Reference Manual. A reference like "1 HW Integration: *ch. 7*" means Volume 1, Hardware Integration Guide, of the HP LTO Ultrium Technical Reference Manual, chapter 7.

Drives—general

Connectors	1 HW Integration: ch. 4
Front panel LEDs	1 HW Integration: ch. 3
Specifications	4 Specifications

Installation and configuration

Connectors	1 HW Integration: ch. 4
Determining the configuration	2 SW Integration: ch. 2
Installation	1 HW Integration: ch. 7
Linux configuration	5 UNIX, Linux, OpenVMS Configuration
Modes of usage	n/a
OpenVMS configuration	5 UNIX, Linux, OpenVMS Configuration
Optimizing performance	1 HW Integration: ch. 6
	2 SW Integration: ch. 4
UNIX configuration	5 UNIX, Linux, OpenVMS Configuration

Operation

Operation	1 HW Integration: ch. 8

Cartridges

Cartridge Memory (LTO-CM)	2 SW Integration: ch. 5
Cartridges	1 HW Integration: ch. 5
Managing the use of cartridges	2 SW Integration: ch. 1
Use of cartridges	2 SW Integration: ch. 3

Interface

FC and SAS host interface guide	3 Host Interface
Commands	3 Host Interface: ch. 5
Error codes	1 HW Integration: ch. 11
Implementation	3 Host Interface: ch. 1
Interpreting sense data	2 SW Integration: ch. 6
Messages	3 Host Interface: ch. 2
Mode pages —see the MODE SENSE command	3 Host Interface: ch. 5
Pre-execution checks	3 Host Interface: ch. 4
Responding to sense keys and ASC/Q	2 SW Integration: ch. 6
Response frames	3 Host Interface: ch. 3
Sense keys and ASC/Q —see REQUEST SENSE command	3 Host Interface: ch. 5
Task management functions	3 Host Interface: ch. 3

Maintenance and troubleshooting

Cleaning	2 SW Integration: <i>ch. 1</i> 2 SW Integration: <i>ch. 5</i>
Troubleshooting	1 HW Integration: ch. 9
Monitoring drive and tape condition	2 SW Integration: ch. 7
Software troubleshooting techniques	2 SW Integration: ch. 1

Dealing with errors

Error codes	1 HW Integration: <i>ch. 11</i>	
Exception handling	2 SW Integration: ch. 7	
Logs—see the LOG SENSE command	3 Host Interface: ch. 5	
TapeAlert log	2 SW Integration: ch. 7	

LTO Ultrium features

Autoload	1 HW Integration: <i>ch. 10</i>
Automation Control Interface (ACI)	1 HW Integration: <i>ch. 10</i>
Cartridge Memory (LTO-CM)	1 HW Integration: ch. 5

	2 SW Integration: ch. 5
Data compression, managing	2 SW Integration: ch. 5
OBDR and CD-ROM emulation	2 SW Integration: ch. 7
Performance optimization	1 HW Integration: ch. 6
	2 SW Integration: ch. 1
Performance, factors affecting	2 SW Integration: ch. 4
Software design	2 SW Integration: ch. 1
Supporting LTO Ultrium features	2 SW Integration: ch. 5

General documents and standardization

See http://www.t10.org/t10_main.htm for INCITS SCSI Primary Commands—3 (SPC-3), SCSI Streaming Commands (SSC-3) and other specifications

Copies of documents of other standards bodies can be obtained from:

INCITS 11 West 42nd Street New York, NY 10036-8002 USA

ISO CP 56

CH-1211 Geneva 20

Switzerland

ECMA 114 Rue du Rhône Tel: +41 22 849 6000

CH-1204 Geneva

Switzerland

Global Engineering 2805 McGaw Tel: 800 854 7179 or 714 261 1455

Documents Irvine, CA 92714

USA

Web URL: http://www.ecma.ch

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